# □ MN101C61D, MN101C61G

Туре	MN101C61D (under development)	MN101C61G			
ROM (×8-bit)	64 K	128 K			
RAM (×8-bit)	3 K	12 K			
Package	TQFP080-P-1212D *Lead-free				
Minimum Instruction Execution Time	Standard:       0.1 µs (at 2.5 V to 3.6 V, 20 MHz)         0.2 µs (at 2.1 V to 3.6 V, 10 MHz)         0.5 µs (at 1.8 V to 3.6 V, 4 MHz)*         125 µs (at 1.8 V to 3.6 V, 32 kHz)*         Double speed:       0.1 µs (at 2.5 V to 3.6 V, 10 MHz)         0.2 µs (at 2.1 V to 3.6 V, 32 kHz)*         Double speed:       0.1 µs (at 2.5 V to 3.6 V, 10 MHz)         0.2 µs (at 2.1 V to 3.6 V, 5 MHz)         0.5 µs (at 1.8 V to 3.6 V, 5 MHz)         0.5 µs (at 1.8 V to 3.6 V, 2 MHz)*         62.5 µs (at 1.8 V to 3.6 V, 32 kHz)*         * The operation guarantee range for flash memory built-in type is 2.2V to 3.0 V or 2.7V to 3.6 V.				
Interrupts	• RESET • Watchdog • External 0 • External 1 • External • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 4 • Time • Serial 0 reception • Serial 0 transmission • Serial 1 recep • Automatic transfer finish • A/D conversion finish • Time	2 • External 3 • External 4 • External 5 er 5 • Timer 6 • Time base otion • Serial 1 transmission • Serial 2 • Serial 3			
Timer Counter	Timer counter 0 : 8-bit × 1 (square-wave/8-bit PWM output, event count, generation of remote control carrier, pulse width measurement) Clock source				
	-	frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation KI oscillation clock frequency; external clock input			
	Timer counter 0, 1 can be cascade-connected.				
	-	frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation KI oscillation clock frequency; external clock input			
	-	frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillation KI oscillation clock frequency; external clock input			
	Timer counter 2, 3 can be cascade-connected.				
	clock frequency; 1/1 of 1/1 of external clock in	frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillatio XI oscillation clock frequency; put frequency			
	Interrupt source coincidence with compa	re register 4			
	Timer counter 5 : 8-bit × 1 (square-wave/8-bit PWM output, event count, pulse width me Clock source	equency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation clock ation clock frequency; frequency			
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	Timer Counter (Continue)	Timer counter 6 : 8-bit freerun timer Clock source 1/1 of system clock frequency; 1/1, 1/4096, 1/8192 of OSC oscillation clock frequency; 1/1, 1/4096, 1/8192 of XI oscillation clock frequency Interrupt source coincidence with compare register 6				
		Timer counter 7 : 16-bit × 1 (square-wave/16-bit PWM output, cycle / duty continuous variable, event count, synchronous output evevt, pulse width measurement, input capture) Clock source				
		Time base timer (one-minute count setting) Clock source				
		Watchdog timer Interrupt source 1/65536, 1/262144, 1/1048576 of system clock frequency				
		DMA	A controller (automatic data transfer) Max. Transfer cycles 255 Starting factor external request, various types of interrupt, software Transfer mode 1-byte transfer, word transfer, burst transfer			
	Serial Interface		ll 0 : synchronous type / UART (full-duplex) × 1 Clock source			
			Serial 1 : synchronous type / UART (full-duplex) × 1 Clock source			
		Seria	<ul> <li>1 2 : synchronous type × 1</li> <li>Clock source</li></ul>			
		Serial 3 : synchronous type/single-master I <sup>2</sup> C × 1 Clock source				
	I/O Pins I/O	62	• Common use • Specified pull-up resistor available • Input/output selectable (bit unit)			
	Input	6	Common use • Specified pull-up resistor available			
-	A/D Inputs	10-Bit × 6-ch. (with S/H)				
Special Ports Buzzer out			put, remote control carrier signal output, high-current drive port			

Special Ports

Buzzer output, remote control carrier signal output, high-current drive port

#### Electrical Characteristics

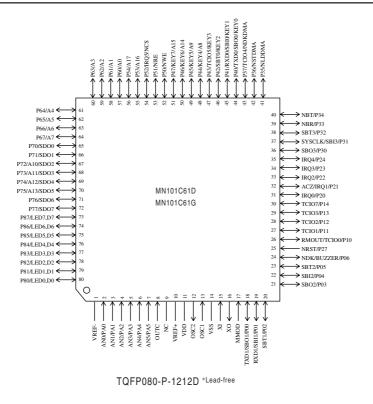
#### Supply current

Parameter	Symbol	Condition		Limit		Unit
Farameter	Symbol	Condition	min	typ	max	
	IDD1	fosc = 20  MHz, VDD = 3  V, (fs = fosc/2)		5	12	mA
Operating supply current	IDD2	fosc = 8.39 MHz, VDD = 3 V, (fs = fosc/2)		2	5	mA
	IDD3	fx = 32.768 kHz, VDD = 3 V, (fs = fx/2)			40	μA
	IDD4	fx = 32.768 kHz, VDD = 3 V, Ta = 25°C		4	8	
Supply current at HALT	IDD5	fx = 32.768 kHz, VDD = 3 V			30	
Supply current at STOP	IDD6	$VDD = 3 V, Ta = 25^{\circ}C$			2	μA
	IDD7	VDD = 3 V			20	μA

Ta =  $-40^{\circ}$ C to  $+85^{\circ}$ C, VDD = 1.8 V to 3.6 V, VSS = 0 V

Note)  $Ta = -20^{\circ}C$  to  $+70^{\circ}C$  for a flash memory built-in version. Supply voltage range ans supply current ratings are also different from the values mentioned above. Refer to Chapter 18 "Flash EEPROM" for detailes

#### Pin Assignment



NC serves as the VPP pin in the MN101CF61G, and cannot be used as a user pin.

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## Support Tool

In-circuit Emulator	PX-ICE101C / D + PX-PRB101C61-TQFP080-P-1212-M		
Flash Memory Built-in Type	Туре	MN101CF61G	
	ROM (× 8-bit)	128 K	
	RAM (× 8-bit)	12 K	
	Minimum instruction execution time	0.1 µs (at 2.7 V to 3.6 V, 20 MHz)	
		0.2 µs (at 2.7 V to 3.6 V, 10 MHz)	
		0.5 µs (at 2.7 V to 3.6 V, 4 MHz)	
		125 µs (at 2.7 V to 3.6 V, 32 kHz)	
	Package	TQFP080-P-1212D *Lead-free	
	Туре	MN101CF60G	
	ROM (× 8-bit)	128 K	
	RAM (× 8-bit)	12 K	
	Minimum instruction execution time	0.1 µs (at 2.5 V to 3.0 V, 20 MHz)	
		0.2 µs (at 2.2 V to 3.0 V, 10 MHz)	
		0.5 µs (at 2.2 V to 3.0 V, 4 MHz)	
		125 µs (at 2.2 V to 3.0 V, 32 kHz)	
	Package	TQFP080-P-1212D *Lead-free	

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